

# HOSTAFORM® MT®8R02

## HOSTAFORM®

Hostaform® MT®8R02 is an improved wear performance grade targeted at injection molding grade with a molecular weight for excellent moldability and optimum properties in demanding applications.

Hostaform® MT®8R02 is a special grade developed for medical industry applications and complies with:

- CFR 21 (177.2470) of the Food and Drug Administration (FDA) and is listed in the Drug Master File (DMF 11559) and the Device Master File (MAF 1079)
- the corresponding EU and national registry regulatory requirements
- biocompatibility in tests corresponding to USP <88> Class VI/ISO 10993
- low residual monomers
- no animal-derived constituents

### Product information

Resin Identification	POM	ISO 1043
Part Marking Code	>POM<	ISO 11469

### Rheological properties

Melt volume-flow rate	8.5 cm <sup>3</sup> /10min	ISO 1133
Temperature	190 °C	
Load	2.16 kg	

### Typical mechanical properties

Tensile modulus	2700 MPa	ISO 527-1/-2
Tensile stress at yield, 50mm/min	62 MPa	ISO 527-1/-2
Tensile strain at yield, 50mm/min	9 %	ISO 527-1/-2
Nominal strain at break	30 %	ISO 527-1/-2
Charpy notched impact strength, 23 °C	8 kJ/m <sup>2</sup>	ISO 179/1eA
Poisson's ratio	0.38 <sup>[C]</sup>	

[C]: Calculated

### Thermal properties

Melting temperature, 10 °C/min	165 °C	ISO 11357-1/-3
Temperature of deflection under load, 1.8 MPa	82 °C	ISO 75-1/-2

### Physical/Other properties

Density	1400 kg/m <sup>3</sup>	ISO 1183
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### Injection

Drying Recommended	no
Drying Temperature	100 °C
Drying Time, Dehumidified Dryer	3 - 4 h
Processing Moisture Content	≤0.2 %
Melt Temperature Optimum	190 °C
Min. melt temperature	180 °C
Max. melt temperature	200 °C
Screw tangential speed	≤0.3 m/s
Mold Temperature Optimum	100 °C

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Min. mould temperature	80 °C
Max. mould temperature	120 °C
Hold pressure range	60 - 120 MPa
Back pressure	4 MPa
Ejection temperature	134 °C

### Characteristics

Processing	Injection Moulding
Delivery form	Pellets
Additives	Release agent
Special characteristics	Low wear / Low friction

### Additional information

Processing Notes

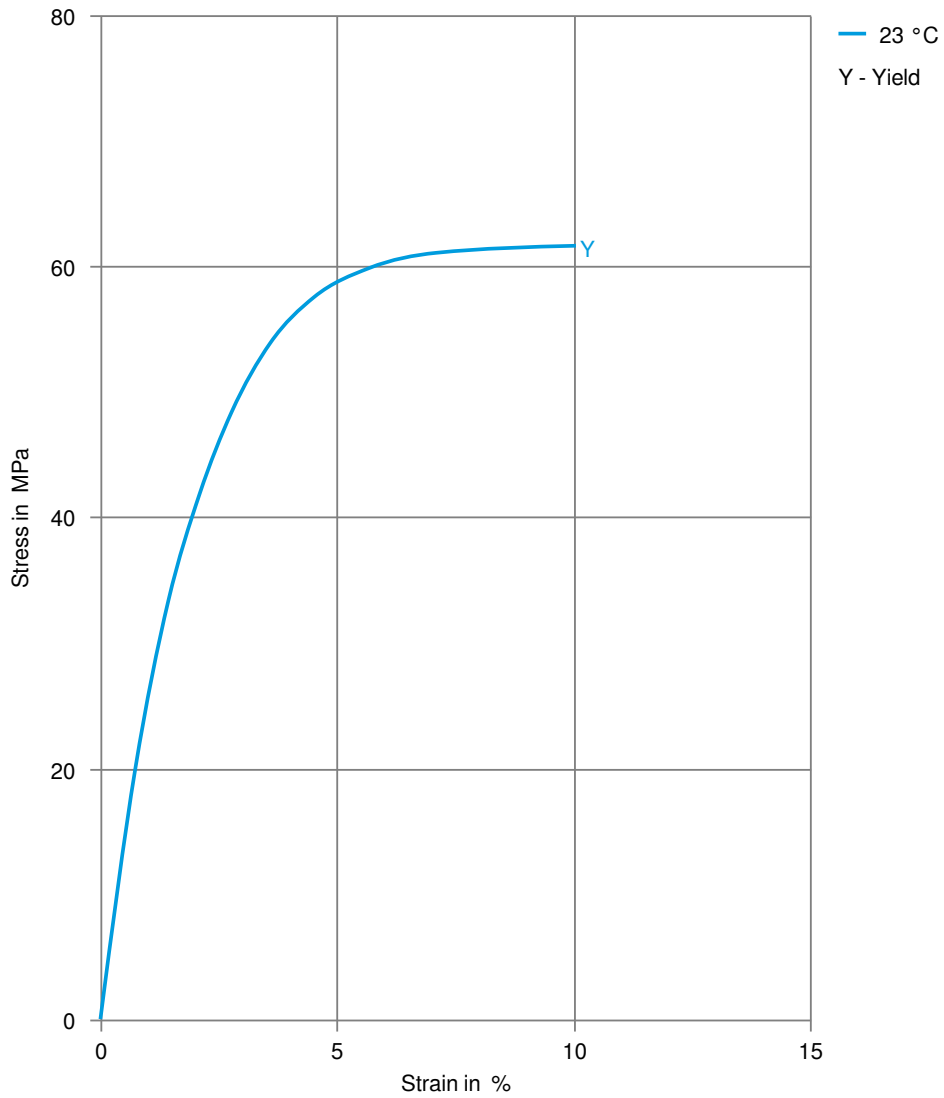
#### Pre-Drying

Drying is not normally required. If material has come in contact with moisture through improper storage or handling, drying may be necessary to prevent splay and odor problems.

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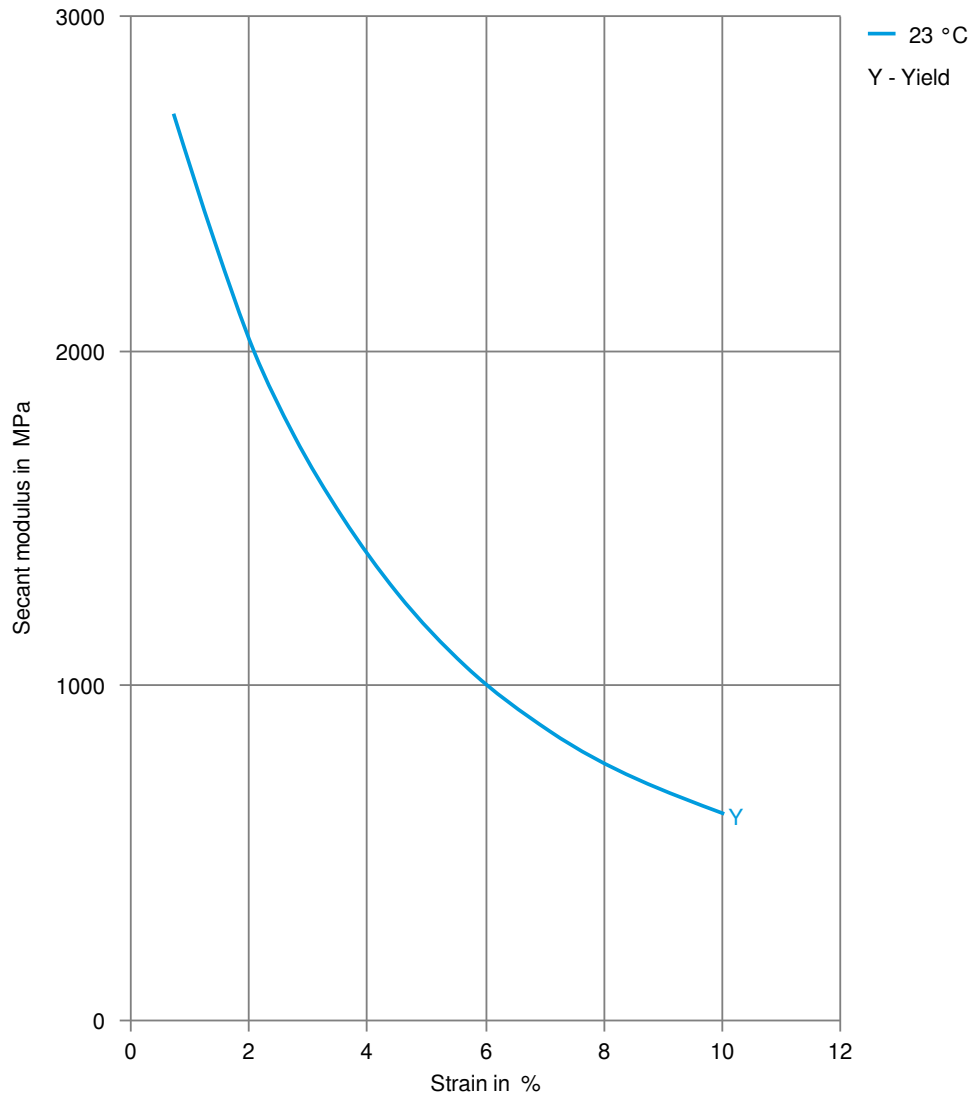
### Stress-strain



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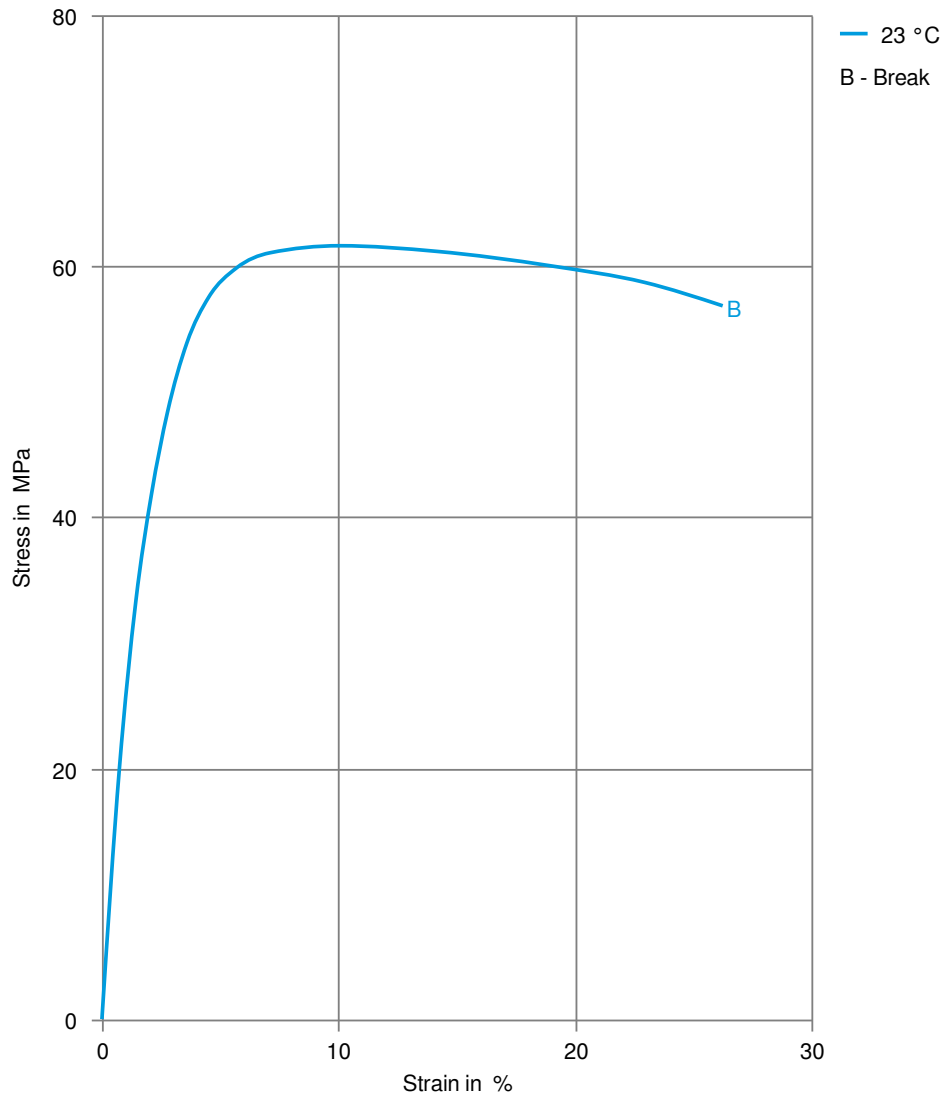
### Secant modulus-strain



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## Stress-strain, 50mm/min



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### Secant modulus-strain, 50mm/min

